









Release Date: 09 August 2022 Version: A1.2

PRODUCT DATASHEET



- ► PLCC6 SMD
- ▶ 5050 1.6t Series
- ► Red / Green / Blue

N0M03S95





5050 1.6t Series





APPLICATIONS:

- **Decoration Lighting**
- Light Strip
- Display
- **Commercial Lighting**

FEATURES (Red/Green/Blue*):

- Package: PLCC6 RGB Top View SMD Package
- Forward Current: 20/20/20mA **Forward Voltage (typ.):** 2.0/3.2/3.2V
- Luminous Flux (typ.): 700/1750/320mcd@20mA
- Colour: Red/Green/Blue
- **CCT/Wavelength:** 622/527/467nm
- Viewing angle: 120/120/120°
- **Materials:**
 - Resin: Silicone (Water Clear)
- Operating Temperature: -40~+85°C
- Storage Temperature: -40~+100°C
- **ESD:** 1000V (HBM)
- **Grouping parameters:**
 - Forward voltage
 - Luminous intensity
 - **Dominant Wavelength**
- Soldering methods: IR Reflow soldering
- Preconditioning: MSL 5 according to JEDEC
- Packing: 12mm tape with max.1000pcs/reel, ø180mm (7'')



CHARACTERISTICS:

Absolute Maximum Characteristics (Ta=25°C)

Parameter	Symbol	Ratings	Unit
Forward Current	I _F	50/30/30*	mA
Pulse Forward Current (duty 1/10; width 0.1ms)	I _{MAX}	100	mA
Power Dissipation	P _D	100/80/80	mW
Reverse Voltage	V _R	5	V
Reverse Current @5V	I _R	10	μΑ
Electrostatic Discharge (HBM)	ESD	1000	V
Junction Temperature	Tj	110	°C
Soldering Temperature	T _{sol}	260	°C
Operating Temperature	T_OPR	-40~+85	°C
Storage Temperature	T _{STG}	-40~+100	°C

^{1. *} In the order of Red/Green/Blue.



Electrical & Optical Characteristics (Ta=25°C)

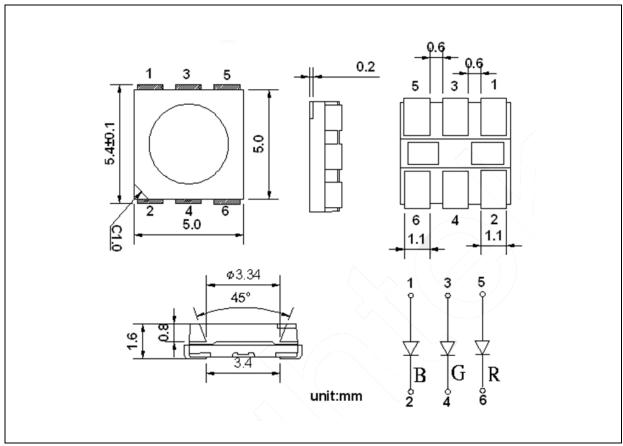
Parameter	Symbol		Values		Unit	Test
Parameter	Зуппоп	Min.	Тур.	Max.	UIIIL	Condition
Red - Forward Voltage	VF	1.8	2.0	2.6	V	I _F =20mA
Red - Luminous Intensity	I _V		700		mcd	I _F =20mA
Red - Wavelength	WP	615		630	nm	I _F =20mA
Green - Forward Voltage	VF	2.8	3.2	3.6	V	I _F =20mA
Green - Luminous Intensity	lv		1750		mcd	I _F =20mA
Green - Wavelength	W _P	520		535	nm	I _F =20mA
Blue - Forward Voltage	VF	2.8	3.2	3.6	V	I _F =20mA
Blue - Luminous Intensity	lv		320		mcd	I _F =20mA
Blue - Wavelength	WP	461		476	nm	I _F =20mA
Viewing Angle	2θ _{1/2}		120		deg	I _F =20mA

^{1.} Luminous intensity (I_V) ±5%, Forward Voltage (V_F) ±0.1V



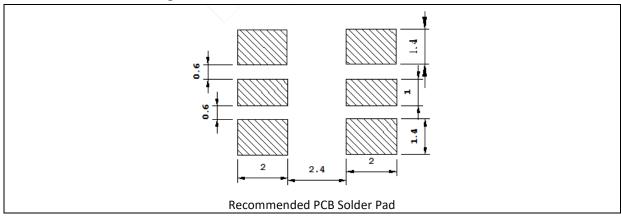
OUTLINE DIMENSION:

Package Dimension:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.1mm, unless otherwise noted.

Recommended Soldering Pad Dimension:



- 1. Dimensions are in millimetre (mm).
- 2. Tolerance ± 0.1 mm with angle tolerance $\pm 0.5^{\circ}$.



BINNING GROUPS:

Forward Voltage Classifications (I_F = 20mA):

Code	Min.	Max.	Unit
R	1.8	2.6	
G	2.8	3.6	V
В	2.8	3.6	

Luminous Intensity Classifications (I_F = 20mA):

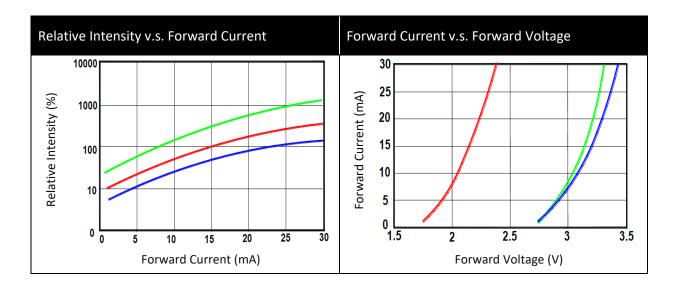
Co	ode	Min.	Max.	Unit
	13	575	720	
R	14	720	900	mcd
	15	900	1125	
	12	1280	1600	
G	13	1600	2000	mcd
	14	2000	2500	
	11	245	305	
В	12	305	385	mcd
	13	385	480	

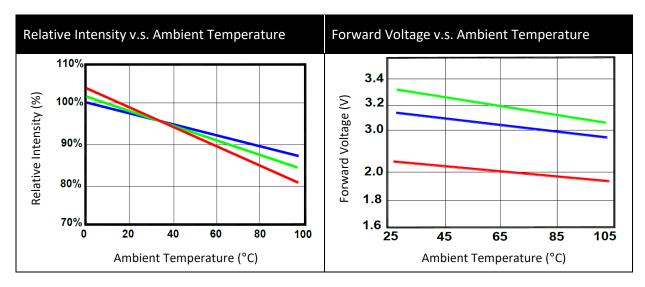
Wavelength Classifications (I_F = 20mA):

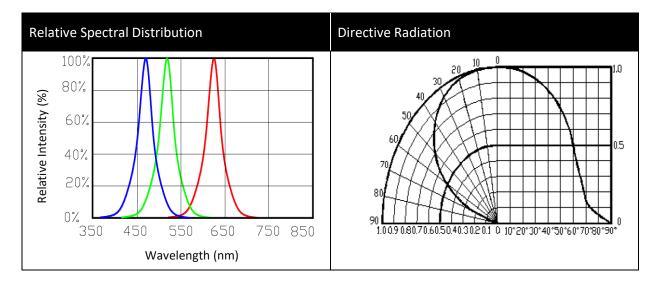
Co	ode	Min.	Max.	Unit
	2	615	620	
R	3	620	625	nm
	4	625	630	
	2	520	525	
G	3	525	530	nm
	4	530	535	
	2	461	466	
В	3	466	471	nm
	4	471	476	



ELECTRO-OPTICAL CHARACTERISTICS:

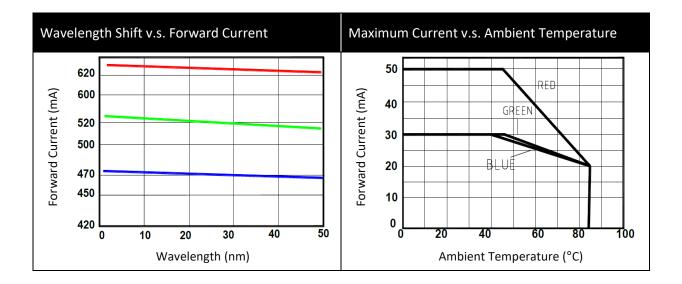








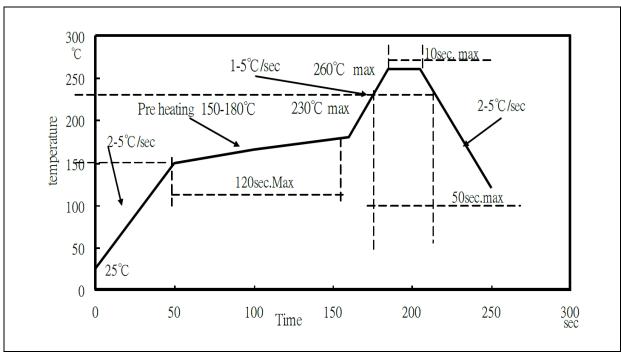
ELECTRO-OPTICAL CHARACTERISTICS:





RECOMMENDED SOLDERING PROFILE:

Lead-free Solder:



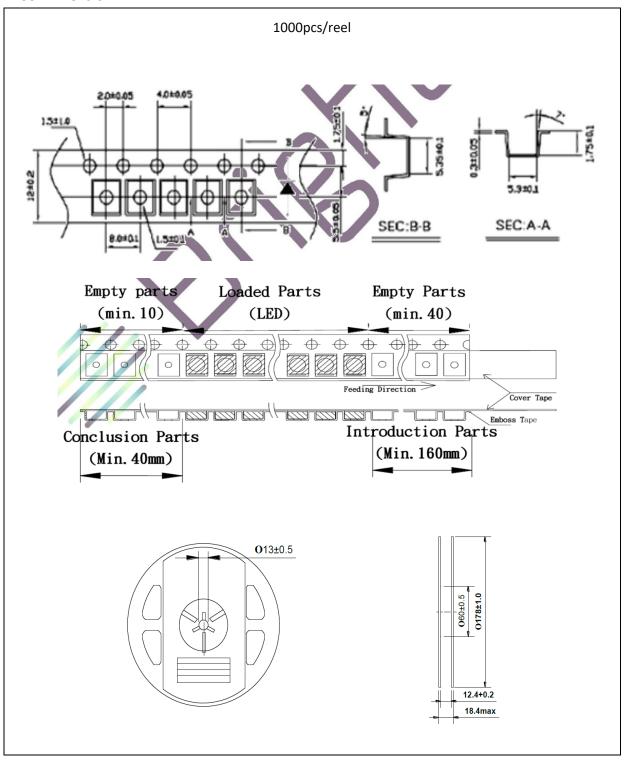
Note:

- 1. Maximum reflow soldering: 3 times.
- 2. Recommended soldering temperature 240°C; maximum soldering temperature should be limited to 260°C.
- 3. Before, during, and after soldering, should not apply stress on the components and PCB board.



PACKING SPECIFICATION:

Reel Dimension:





PRECAUTIONS OF USE:

Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 months at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp-proof box with descanting agent <10% R.H. and apply baking before use.

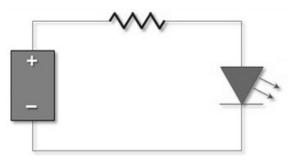
Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

60±3°C x 6hrs and <5%RH, taped / reel package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

Testing Circuit:



Must apply resistor(s) for protection (over current proof).

Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.



REVISION RECORD:

Version	Date	Summary of Revision
A1.0	03/03/2016	Datasheet set-up.
A1.1	10/01/2019	Revise bin range.
A1.2	09/08/2022	Revise storage condition.